

PGA206
PGA207

High-Speed Programmable Gain INSTRUMENTATION AMPLIFIER

FEATURES

- **DIGITALLY PROGRAMMABLE GAINS:**
PGA206: $G=1, 2, 4, 8V/V$
PGA207: $G=1, 2, 5, 10V/V$
- **TRUE INSTRUMENTATION AMP INPUT**
- **FAST SETTLING: $3.5\mu s$ to 0.01%**
- **FET INPUT: $I_B = 100pA$ max**
- **INPUT PROTECTION: $\pm 40V$**
- **LOW OFFSET VOLTAGE: $1.5mV$ max**
- **16-PIN DIP, SOL-16 SOIC PACKAGES**

APPLICATIONS

- **MULTIPLE-CHANNEL DATA ACQUISITION**
- **MEDICAL, PHYSIOLOGICAL AMPLIFIER**
- **PC-CONTROLLED ANALOG INPUT BOARDS**

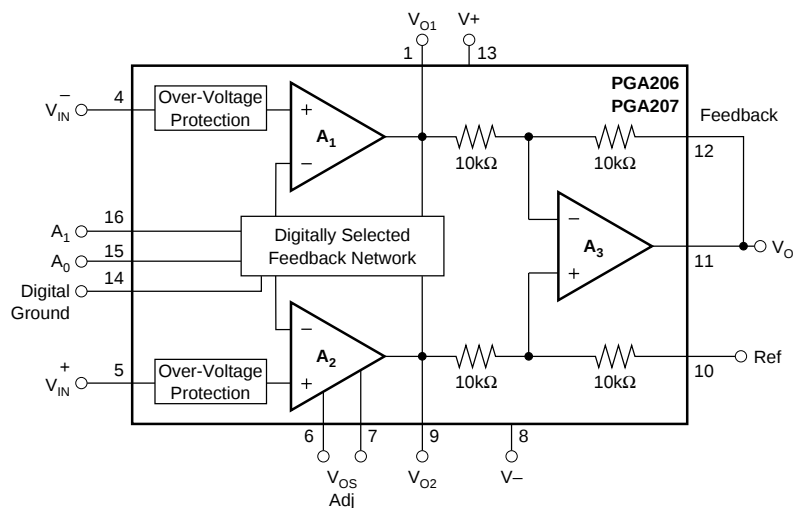
DESCRIPTION

The PGA206 and PGA207 are digitally programmable gain instrumentation amplifiers that are ideally suited for data acquisition systems.

The PGA206 and PGA207's fast settling time allows multiplexed input channels for excellent system efficiency. FET inputs eliminate I_B errors due to analog multiplexer series resistance.

Gains are selected by two CMOS/TTL-compatible address lines. Analog inputs are internally protected for overloads up to $\pm 40V$, even with the power supplies off. The PGA206 and PGA207 are laser-trimmed for low offset voltage and low drift.

The PGA206 and PGA207 are available in 16-pin plastic DIP and SOL-16 surface-mount packages. Both are specified for $-40^\circ C$ to $+85^\circ C$ operation.



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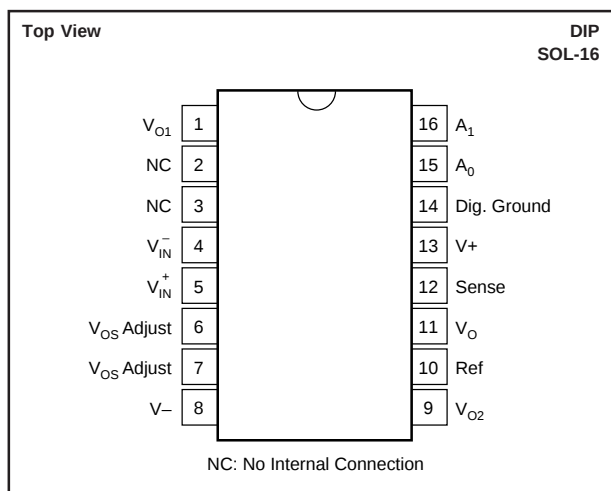
At $T_A = +25^\circ\text{C}$, $V_S = \pm 15\text{V}$, $R_I = 2\text{k}\Omega$ unless otherwise noted.

* Specification same as PGA206P or PGA207P.

NOTES: (1) Input common-mode range varies with output voltage—see typical curves. (2) Guaranteed by wafer test.

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PIN CONFIGURATION



PACKAGE INFORMATION

PRODUCT	PACKAGE	PACKAGE DRAWING NUMBER ⁽¹⁾
PGA206PA	16-Pin Plastic DIP	180
PGA206P	16-Pin Plastic DIP	180
PGA206UA	SOL-16 Surface Mount	211
PGA206U	SOL-16 Surface Mount	211
PGA207PA	16-Pin Plastic DIP	180
PGA207P	16-Pin Plastic DIP	180
PGA207UA	SOL-16 Surface Mount	211
PGA207U	SOL-16 Surface Mount	211

NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix C of Burr-Brown IC Data Book.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage	±18V
Analog Input Voltage Range	±40V
Logic Input Voltage Range	±V _S
Output Short-Circuit (to ground)	Continuous
Operating Temperature	–40°C to +125°C
Storage Temperature	–40°C to +125°C
Junction Temperature	+150°C
Lead Temperature (soldering –10s)	+300°C

ORDERING INFORMATION

PRODUCT	GAINS	PACKAGE	TEMPERATURE RANGE
PGA206PA	1, 2, 4, 8V/V	16-Pin Plastic DIP	–40°C to +85°C
PGA206P	1, 2, 4, 8V/V	16-Pin Plastic DIP	–40°C to +85°C
PGA206UA	1, 2, 4, 8V/V	SOL-16 Surface-Mount	–40°C to +85°C
PGA206U	1, 2, 4, 8V/V	SOL-16 Surface-Mount	–40°C to +85°C
PGA207PA	1, 2, 5, 10V/V	16-Pin Plastic DIP	–40°C to +85°C
PGA207P	1, 2, 5, 10V/V	16-Pin Plastic DIP	–40°C to +85°C
PGA207UA	1, 2, 5, 10V/V	SOL-16 Surface-Mount	–40°C to +85°C
PGA207U	1, 2, 5, 10V/V	SOL-16 Surface-Mount	–40°C to +85°C



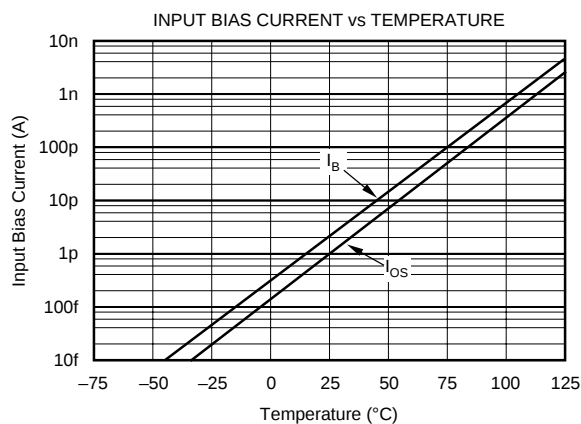
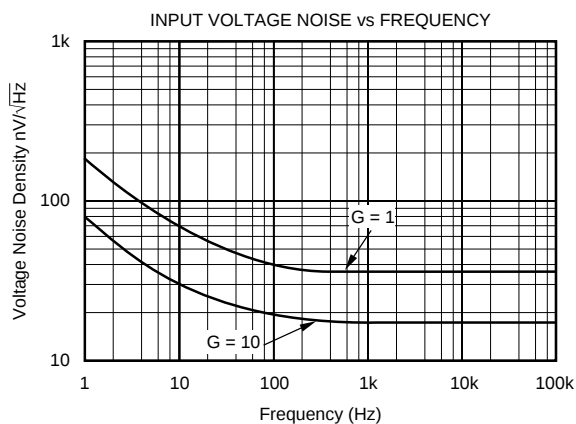
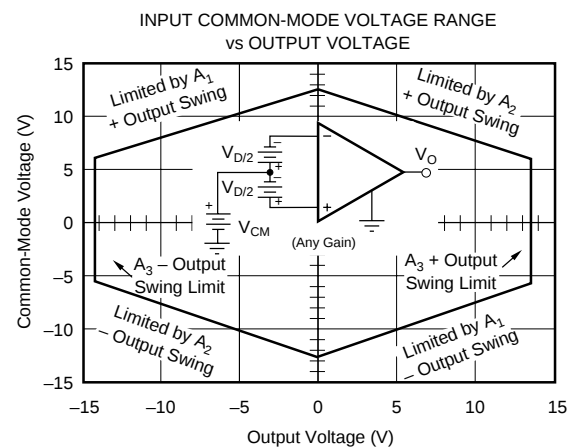
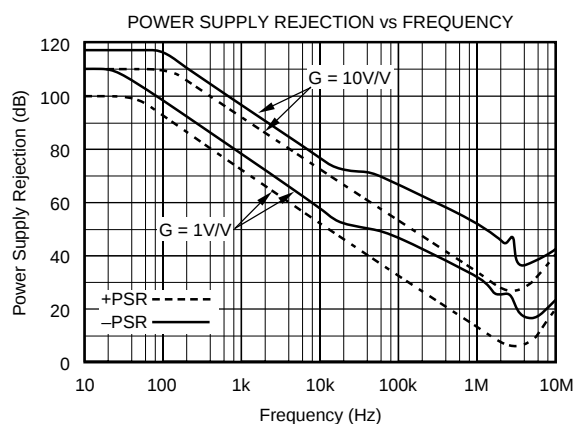
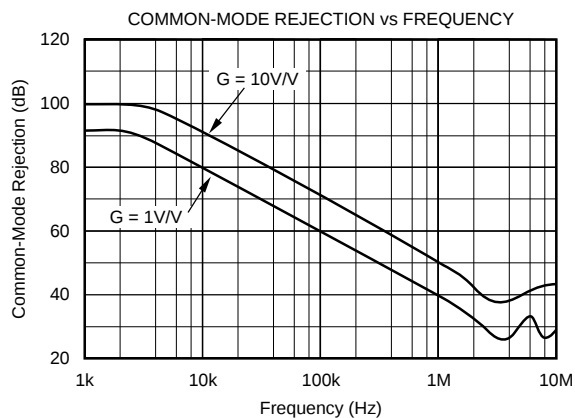
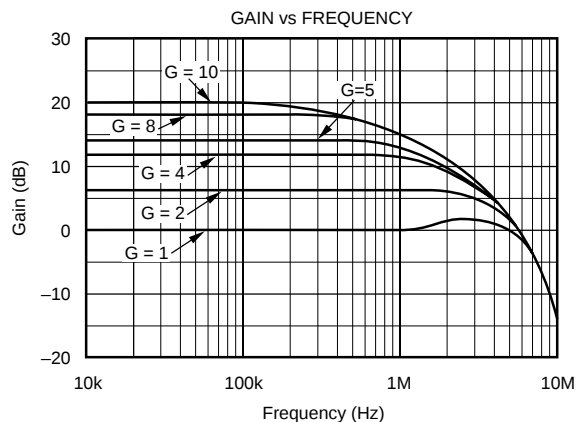
ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

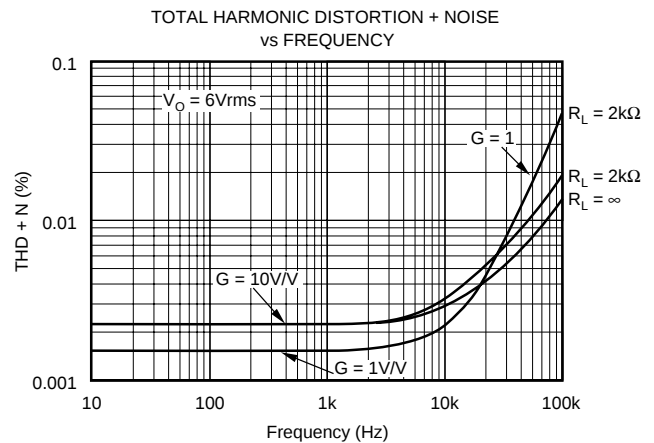
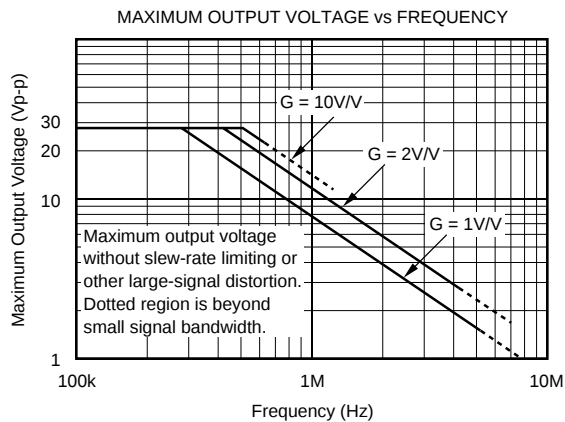
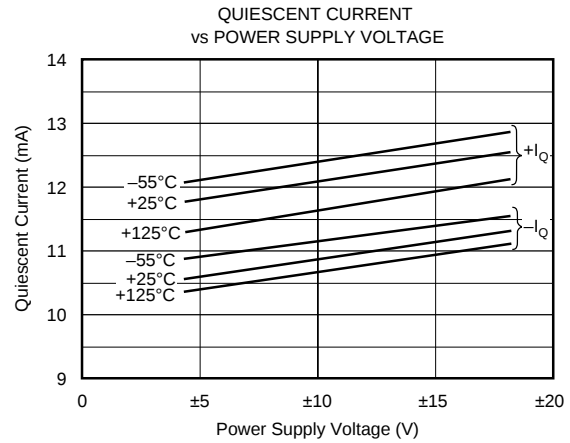
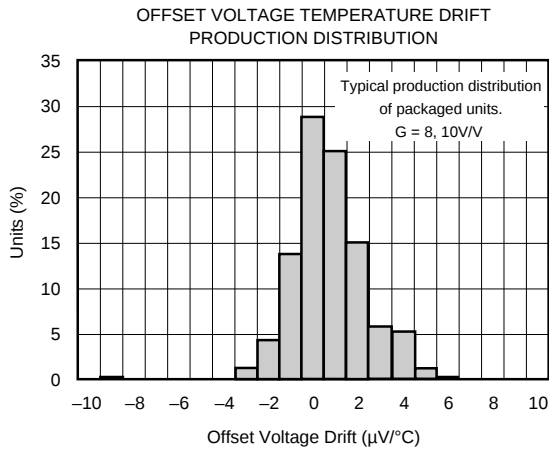
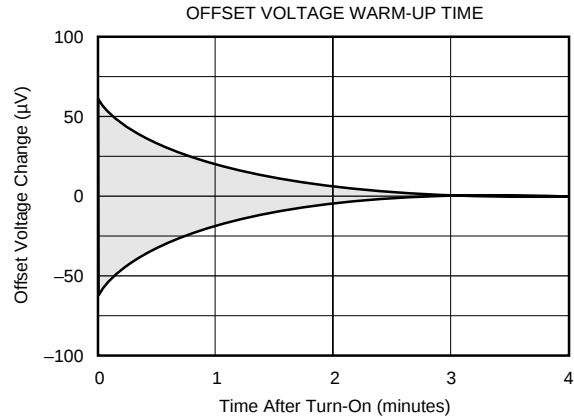
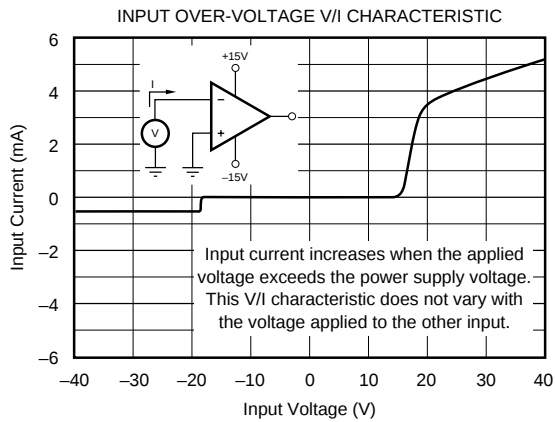
TYPICAL PERFORMANCE CURVES

At $T_A = +25^\circ\text{C}$, and $V_S = \pm 15\text{V}$, unless otherwise noted.



TYPICAL PERFORMANCE CURVES (CONT)

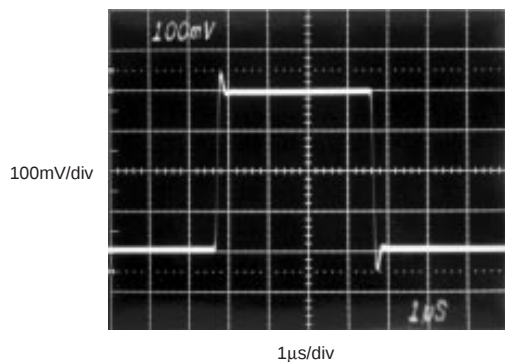
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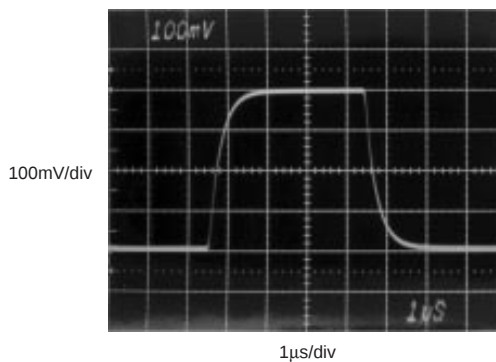
TYPICAL PERFORMANCE CURVES (CONT)

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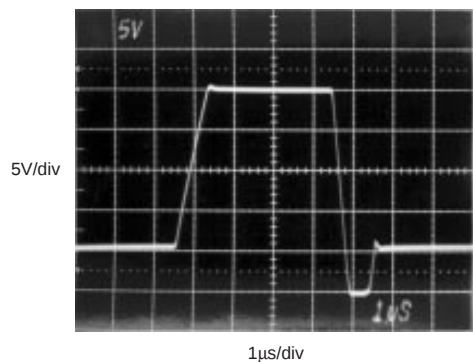
SMALL SIGNAL RESPONSE
 $G = 1$, $C_L = 50\text{pF}$



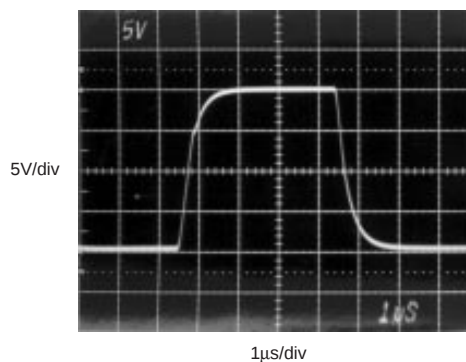
SMALL SIGNAL RESPONSE
 $G = 10$, $C_L = 50\text{pF}$



LARGE SIGNAL RESPONSE
 $G = 1$, $C_L = 50\text{pF}$



LARGE SIGNAL RESPONSE
 $G = 10$, $C_L = 50\text{pF}$



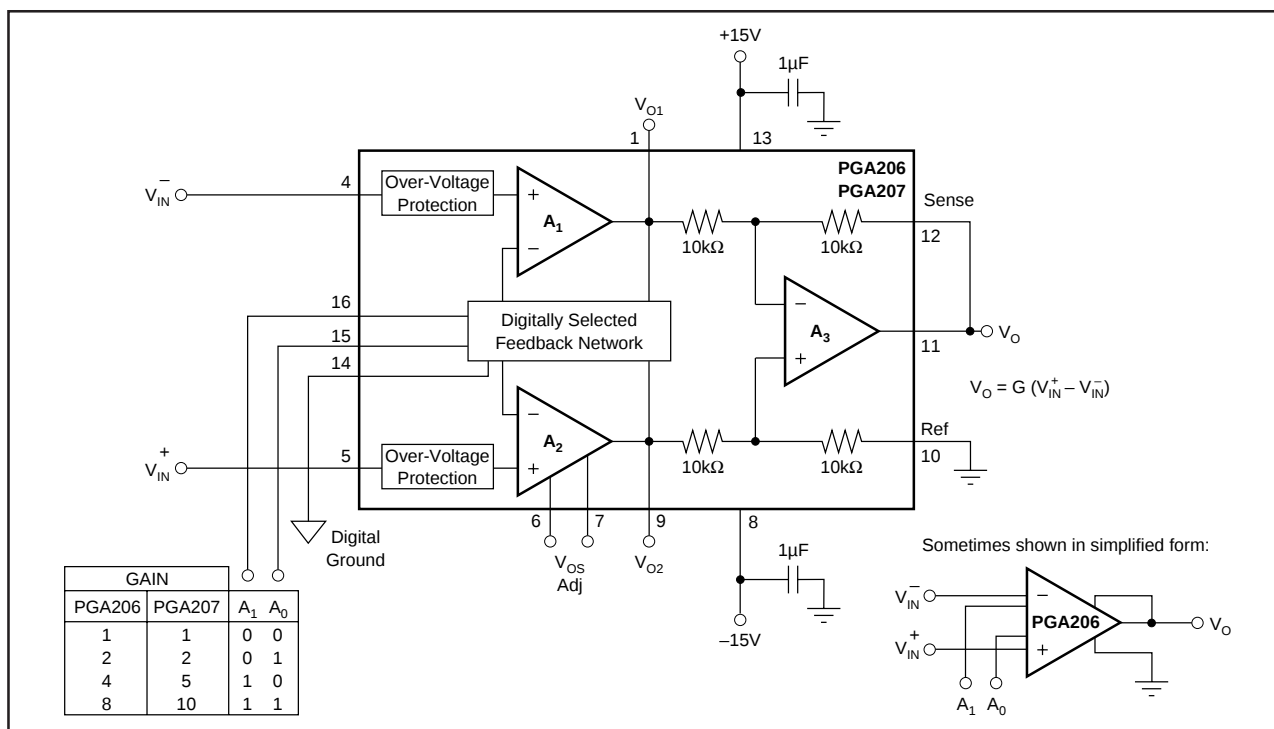


FIGURE 1. Basic Connections.

APPLICATIONS INFORMATION

Figure 1 shows the circuit diagram for basic operation of the PGA206 or PGA207. Applications with noisy or high impedance power supplies may require decoupling capacitors close to the device pins as shown.

The output is referred to the output reference (Ref) terminal which is normally grounded. This must be a low-impedance connection to assure good common-mode rejection. A resistance of 2Ω in series with the Ref pin will cause a typical device to degrade to approximately 80dB CMR ($G = 1$).

The output sense connection (pin 12) must be connected to the output terminal (pin 11) for proper operation. This connection can be made at the load for best accuracy.

DIGITAL INPUTS

The digital inputs A_0 and A_1 select the gain according to the logic table in Figure 1. Logic “1” is defined as a voltage greater than 2V above digital ground potential (pin 14). Digital ground can be connected to any potential ranging from the V_- power supply to 4V less than V_+ . Digital ground is usually equal to analog ground potential and the two grounds are connected at the power supply. The digital inputs interface directly to CMOS and TTL logic.

A nearly constant current of approximately 1.2mA flows in the digital ground pin. It is good practice to return digital ground through a separate connection path so that analog ground is not affected by the digital ground current.

The digital inputs, A_0 and A_1 , are not latched. A change in logic input immediately selects a new gain. Switching time of the logic is approximately 500ns. The time to respond to gain change is equal to switching time, plus the time it takes the amplifier to settle to a new output voltage in the newly selected gain (see settling time specifications).

Many applications use an external logic latch to acquire gain control data from a high speed digital bus. Using an external latch isolates the high speed digital bus from sensitive analog circuitry. Locate the digital latch as far as practical from analog circuitry to avoid coupling digital noise into analog input circuitry.

OFFSET VOLTAGE ADJUSTMENT

The PGA206 and PGA207 are laser trimmed for very low offset voltage and drift. Many applications require no external offset adjustment. Multiplexed data acquisition systems generally correct offset by grounding the inputs of one channel to measure offset voltage. Stored offset values for each gain are then subtracted from subsequent readings of other channels.

Figure 2 shows optional offset voltage trim circuits. Offset voltage changes with the selected gain. To adjust for low offset voltage in all gains, both input and output offsets must be trimmed.

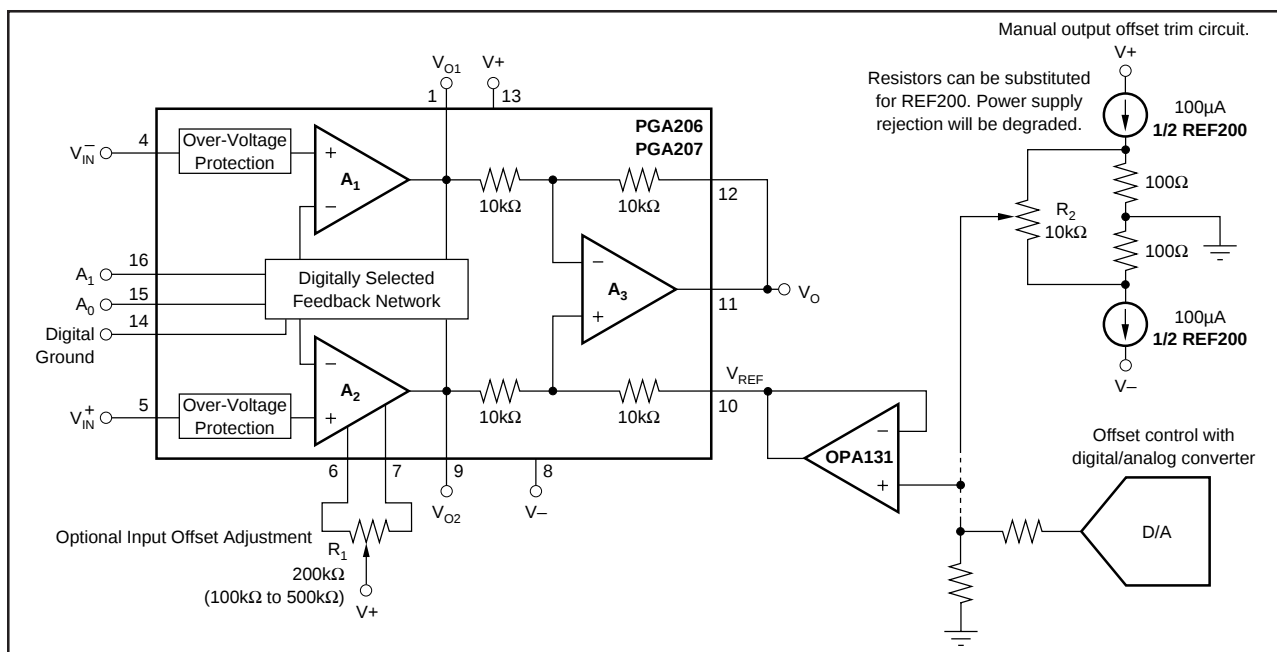


FIGURE 2. Optional Offset Voltage Trim Circuits.

R_1 adjusts the offset of the input amplifiers. Output stage offset is adjusted with R_2 . A buffer op amp is required in the output offset adjustment circuit, as shown, to assure that the Ref pin is driven by a low source impedance. To adjust for low offset voltage in all gains, first adjust the input stage offset in the highest gain. Then adjust the output stage offset (R_2) in $G = 1$. Iterate the adjustments for lowest offset in all gains.

Offset can also be adjusted under processor control with a D/A converter as shown in Figure 2. The D/A's output voltage can be reduced with a resistor divider for better adjustment resolution, but an op amp buffer following the divider is required to provide a low source impedance to the ref terminal. A different offset value is required for each amplifier gain.

INPUT BIAS CURRENT RETURN PATH

The FET inputs of the PGA206 and PGA207 provide extremely high input impedance. Still, a path must be provided for the bias current of each input. Figure 3 shows provisions for an input bias current path. Without a bias current return path, the inputs will float to a potential which exceeds the linear input voltage range and the input amplifiers will saturate.

If the differential source resistance is low, a bias current return path can be connected to only one input (see thermocouple example in Figure 3). With higher source impedance, using two resistors provides a balanced input with possible advantages of lower input offset voltage due to bias current and better common-mode rejection.

Many sources or sensors inherently provide a path for input bias current (e.g. the bridge sensor shown in Figure 3). These applications do not require additional resistor(s) for proper operation.

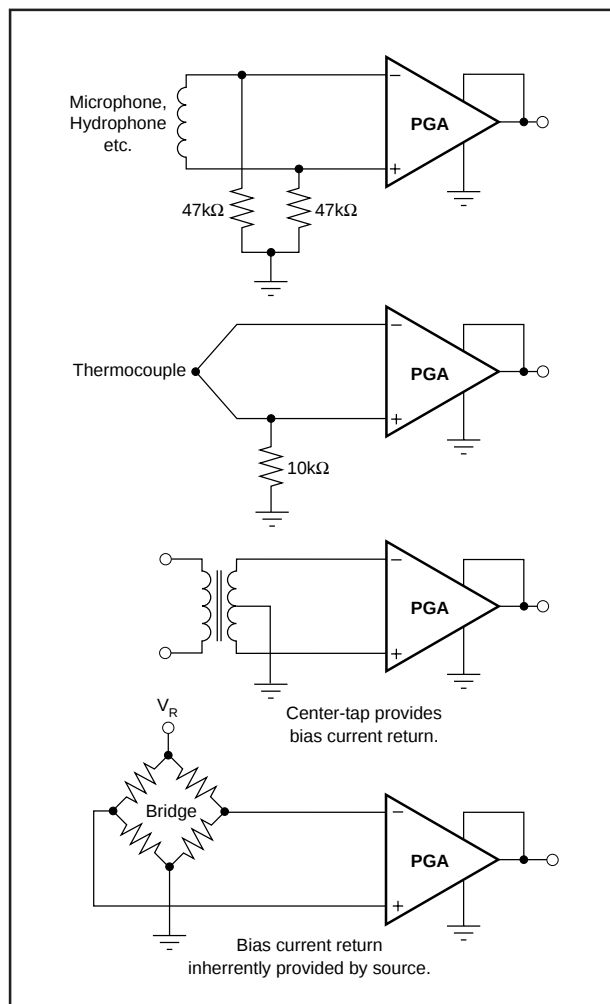


FIGURE 3. Providing an Input Bias Current Path.

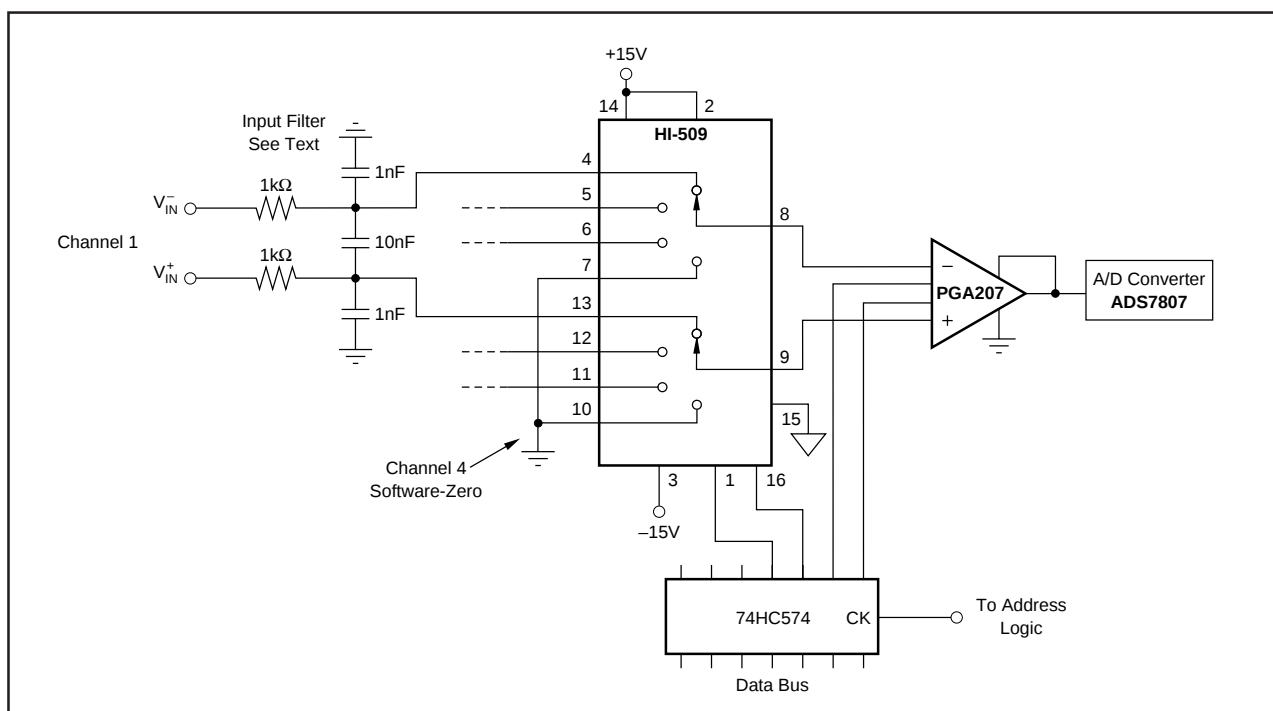


FIGURE 4. Multiplexed-Input Signal Acquisition System.

INPUT COMMON-MODE RANGE

The linear input voltage range of the PGA206 and PGA207 is from approximately 2.3V below the positive supply voltage to 1.5V above the negative supply. As a differential input voltage causes output voltage to increase, however, the linear input range is limited by the output voltage swing of amplifiers A_1 and A_2 . So the linear common-mode input range is related to the output voltage of the complete amplifier. This behavior also depends on supply voltage—see performance curves “Input Common-Mode Range vs Output Voltage”.

Input overload can produce an output voltage that appears normal. For example, if an input overload condition drives both input amplifiers to their positive output swing limit, the difference voltage measured by the output amplifier will be near zero. The output of the PGA206 or PGA207 will be near 0V even though both inputs are overloaded. This condition can be detected by sensing the voltage on the V_{O1} and V_{O2} pins to determine whether they are within their linear operating range.

INPUT PROTECTION

The inputs of the PGA206 and PGA207 are individually protected for voltages up to $\pm 40V$. For example, a condition of -40V on one input and +40V on the other input will not cause damage. Internal circuitry on each input provides low series impedance under normal signal conditions. If the input is overloaded, the protection circuitry limits the input current to a safe value. The typical performance curve “Input Overload V/I Characteristic” shows this behavior. The inputs are protected even if no power supply voltage is applied.

MULTIPLEXED INPUTS

The PGA206 and PGA207 are ideally suited for multiple channel data acquisition. Figure 4 shows a typical application with an analog multiplexer used to connect one of four differential input signals to a single PGA207.

Careful circuit layout will help preserve accuracy of multiplexed signals. Run the inverting and non-inverting connections of each channel parallel to each other over a ground plane, or directly adjacent on top and bottom of the circuit board. Grounded guard traces between channels help reduce stray signal pick-up.

Multiplexed signals from high impedance sources require special care. As inputs are switched by the multiplexer, charge can be injected into the source, disturbing the input signal. Since many such sources involve slow signals, a simple R/C filter at the input can be used to dramatically reduce this effect. The arrangement shown filters both the differential signal and common-mode noise.

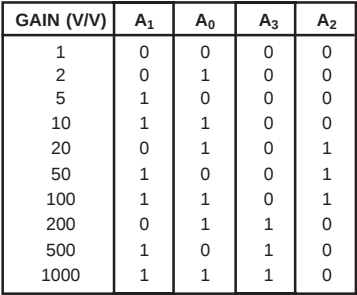


FIGURE 6. Wide Gain Range Programmable IA.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
PGA206PA	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	PGA206PA
PGA206PA.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	PGA206PA
PGA206UA	Active	Production	SOIC (DW) 16	40 TUBE	Yes	NIPDAU-DCC	Level-3-260C-168 HR	-40 to 85	PGA206UA
PGA206UA.A	Active	Production	SOIC (DW) 16	40 TUBE	Yes	NIPDAU-DCC	Level-3-260C-168 HR	-40 to 85	PGA206UA
PGA206UAG4	Active	Production	SOIC (DW) 16	40 TUBE	Yes	NIPDAU-DCC	Level-3-260C-168 HR	-40 to 85	PGA206UA
PGA207UA	Active	Production	SOIC (DW) 16	40 TUBE	Yes	NIPDAU-DCC	Level-3-260C-168 HR	-40 to 85	PGA207UA
PGA207UA.A	Active	Production	SOIC (DW) 16	40 TUBE	Yes	NIPDAU-DCC	Level-3-260C-168 HR	-40 to 85	PGA207UA
PGA207UA/1K	Active	Production	SOIC (DW) 16	1000 LARGE T&R	Yes	NIPDAU-DCC	Level-3-260C-168 HR	-40 to 85	PGA207UA
PGA207UA/1K.A	Active	Production	SOIC (DW) 16	1000 LARGE T&R	Yes	NIPDAU-DCC	Level-3-260C-168 HR	-40 to 85	PGA207UA

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

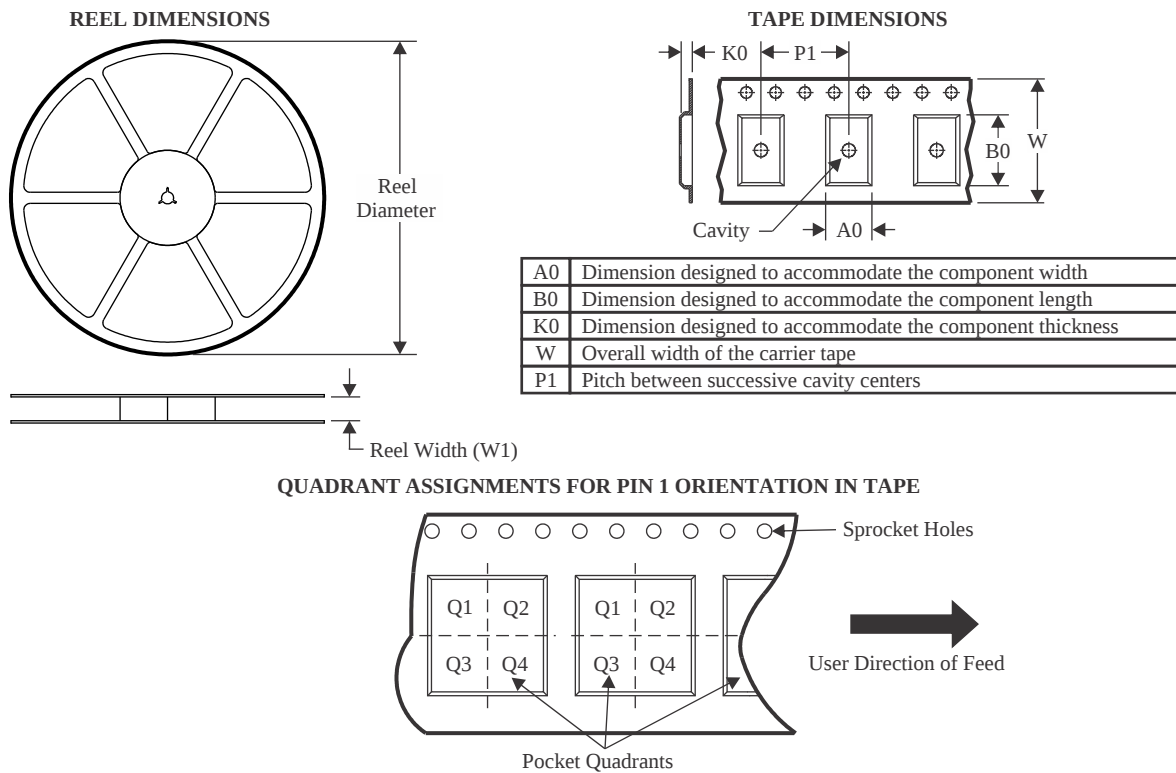
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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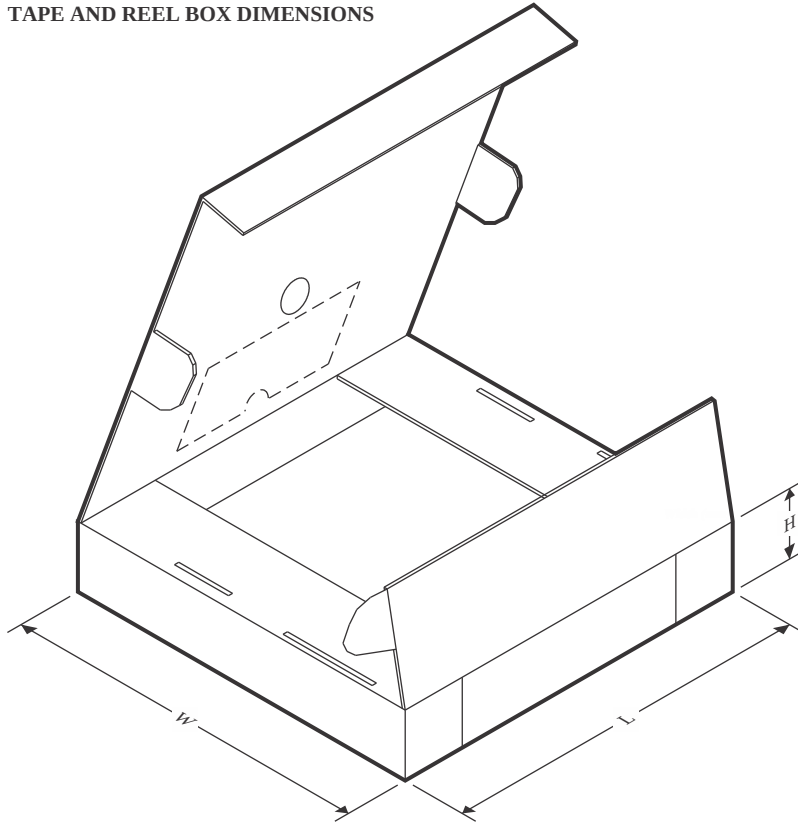
TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
PGA207UA/1K	SOIC	DW	16	1000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
PGA207UA/1K	SOIC	DW	16	1000	356.0	356.0	35.0

TUBE


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
PGA206PA	N	PDIP	16	25	506	13.97	11230	4.32
PGA206PA.A	N	PDIP	16	25	506	13.97	11230	4.32
PGA206UA	DW	SOIC	16	40	507	12.83	5080	6.6
PGA206UA.A	DW	SOIC	16	40	507	12.83	5080	6.6
PGA206UAG4	DW	SOIC	16	40	507	12.83	5080	6.6
PGA207UA	DW	SOIC	16	40	507	12.83	5080	6.6
PGA207UA.A	DW	SOIC	16	40	507	12.83	5080	6.6

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